## 1. General description

The 74LVC169 is a high-performance, low-power, low-voltage, Si-gate CMOS device and superior to most advanced CMOS compatible TTL families.

The 74LVC169 is a synchronous presettable 4-bit binary counter which features an internal look-ahead carry circuitry for cascading in high-speed counting applications. Synchronous operation is provided by having all flip-flops clocked simultaneously so that the output (pins Q0 to Q3) change coincident with each other when so instructed by the count-enable (pins $\overline{\mathrm{CEP}}$ and $\overline{\mathrm{CET}}$ ) inputs and internal gating. This mode of operation eliminates the output counting spikes that are normally associated with asynchronous (ripple clock) counters. A buffered clock (pin CP) input triggers the four flip-flops on the LOW-to-HIGH transition of the clock. The counter is fully programmable; that is, the outputs may be preset to any number between 0 and it's maximum count. Presetting is synchronous with the clock and takes place regardless of the levels of the count enable inputs. A LOW level on the parallel enable (pin $\overline{P E}$ ) input disables the counter and causes the data at the Dn input to be loaded into the counter on the next LOW-to-HIGH transition of the clock. The direction of the counting is controlled by the up/down (pin U/ $\overline{\mathrm{D}}$ ) input. When pin U/D is HIGH, the counter counts up, when LOW, it counts down. The look-ahead carry circuitry is provided for cascading counters for n-bit synchronous applications without additional gating. Instrumental in accomplishing this function are two count-enable (pins $\overline{\mathrm{CEP}}$ and $\overline{\mathrm{CET}}$ ) inputs and a terminal count (pin $\overline{\mathrm{TC}}$ ) output. Both count-enable (pins $\overline{\mathrm{CEP}}$ and $\overline{\mathrm{CET}}$ ) inputs must be LOW to count. Input pin $\overline{\mathrm{CET}}$ is fed forward to enable the terminal count (pin $\overline{\mathrm{TC}}$ ) output. Pin $\overline{\mathrm{TC}}$ thus enabled will produce a LOW-level output pulse with a duration approximately equal to a HIGH level portion of pin Q0 output. The LOW level pin TC pulse is used to enable successive cascaded stages. The 74LVC169 use edge triggered J-K type flip-flops and have no constraints on changing the control of data input signals in either state of the clock. The only requirement is that the various inputs attain the desired state at least a set-up time before the next LOW-to-HIGH transition of the clock and remain valid for the recommended hold time thereafter. The parallel load operation takes precedence over the other operations, as indicated in the mode select table. When pin $\overline{\text { PE }}$ is LOW, the data on the input pins D0 to D3 enter the flip-flops on the next LOW-to-HIGH transition of the clock. In order for counting to occur, both pins $\overline{\mathrm{CEP}}$ and $\overline{\mathrm{CET}}$ must be LOW and pin $\overline{\mathrm{PE}}$ must be HIGH. The pin $U / \bar{D}$ input determines the direction of the counting. The terminal count output pin $\overline{T C}$ output is normally HIGH and goes LOW, provided that pin $\overline{\mathrm{CET}}$ is LOW, when a counter reaches 15 in the count up mode. The pin $\overline{\mathrm{TC}}$ output state is not a function of the count-enable parallel (pin $\overline{\mathrm{CEP}}$ ) input level. Since pin $\overline{\mathrm{TC}}$ signal is derived by decoding the flip-flop states, there exists the possibility of decoding spikes on pin TC. For this reason the use of pin $\overline{\mathrm{TC}}$ as a clock signal is not recommended; see the following logic equations:
count enable $=\overline{\mathrm{CEP}} \times \overline{\mathrm{CET}} \times \overline{\mathrm{PE}}$
count up: TC $=$ Q3 $\times$ Q2 $\times$ Q1 $\times$ Q0 $\times \mathrm{CET} \times(\mathrm{U} / \overline{\mathrm{D}})$
count down: TC $=\overline{\mathrm{Q} 3} \times \overline{\mathrm{Q} 2} \times \overline{\mathrm{Q} 1} \times \overline{\mathrm{Q} 0} \times \mathrm{CET} \times(\overline{\mathrm{U}} / \mathrm{D})$.

## 2. Features

- 5 V tolerant inputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- Inputs accept voltages up to 5.5 V
- Complies with JEDEC standard JESD8-B/JESD36
- Up/down counting
- Two count enable inputs for n-bit cascading
- Built-in look-ahead carry capability
- Presettable for programmable operation
- ESD protection:
- HBM EIA/JESD22-A114-B exceeds 2000 V
- MM EIA/JESD22-A115-A exceeds 200 V.
- Multiple package options
- Specified from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ and from $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.


## 3. Quick reference data

Table 1: Quick reference data
$G N D=0 \mathrm{~V} ; T_{\text {amb }}=25^{\circ} \mathrm{C} ; t_{r}=t_{f} \leq 2.5 \mathrm{~ns}$.

| Symbol | Parameter | Conditions |  | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $t_{\text {PHL }}$, <br> tplh | propagation delay | $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF} ; \mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}$ |  |  |  |  |  |
|  | CP to Qn |  |  | - | 4.0 | - | ns |
|  | CP to $\overline{T C}$ |  |  | - | 4.8 | - | ns |
|  | $\overline{\mathrm{CET}}$ to $\overline{\mathrm{TC}}$ |  |  | - | 4.1 | - | ns |
|  | $\mathrm{U} / \overline{\mathrm{D}}$ to $\overline{\mathrm{TC}}$ |  |  | - | 3.7 | - | ns |
| $\mathrm{f}_{\text {max }}$ | maximum clock frequency |  |  | - | 200 | - | MHz |
| $\mathrm{C}_{1}$ | input capacitance |  |  | - | 5.0 | - | pF |
| CPD | power dissipation capacitance per gate |  | [1] [2] | - | 20 | - | pF |

[1] $C_{P D}$ is used to determine the dynamic power dissipation ( $\mathrm{P}_{\mathrm{D}}$ in $\mu \mathrm{W}$ ).
$P_{D}=C_{P D} \times V_{C C}^{2} \times f_{i} \times N+\Sigma\left(C_{L} \times V_{C C}{ }^{2} \times f_{0}\right)$ where:
$\mathrm{f}_{\mathrm{i}}=$ input frequency in MHz ;
$\mathrm{f}_{\mathrm{o}}=$ output frequency in MHz;
$\mathrm{C}_{\mathrm{L}}=$ output load capacity in pF ;
$\mathrm{V}_{\mathrm{CC}}=$ supply voltage in Volts;
$\mathrm{N}=$ number of inputs switching;
$\Sigma\left(C_{L} \times V_{C C}{ }^{2} \times f_{0}\right)=$ sum of the outputs.
[2] The condition is $\mathrm{V}_{\mathrm{I}}=\mathrm{GND}$ to $\mathrm{V}_{\mathrm{CC}}$.

## 4. Ordering information

Table 2: Ordering information

| Type number | Temperature range | Package |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  |  | Name | Description | Version |
| 74LVC169D | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | SO16 | plastic small outline package; 16 leads; body width 3.9 mm | SOT109-1 |
| 74LVC169DB | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | SSOP16 | plastic shrink small outline package; 16 leads; body width 5.3 mm | SOT338-1 |
| 74LVC169PW | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | TSSOP16 | plastic thin shrink small outline package; 16 leads; body width 4.4 mm | SOT403-1 |
| 74LVC169BQ | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | DHVQFN16 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body $2.5 \times 3.5 \times 0.85 \mathrm{~mm}$ | SOT763-1 |

## 5. Functional diagram




Fig 3. Logic diagram.

## 6. Pinning information

### 6.1 Pinning



Fig 4. Pin configuration SO16 and (T)SSOP16 package.

(1) The die substrate is attached to this pad using conductive die material. It can not be used as a supply pin or input.

Fig 5. Pin configuration DHVQFN16 package.

### 6.2 Pin description

Table 3: Pin description

| Symbol | Pin | Description |
| :--- | :--- | :--- |
| U/D | 1 | up/down control input |
| CP | 2 | clock input (LOW-to-HIGH, edge-triggered) |
| D0 | 3 | data input |
| D1 | 4 | data input |
| D2 | 5 | data input |
| D3 | 6 | data input |
| $\overline{C E P}$ | 7 | count enable input (active LOW) |
| GND | 8 | ground (OV) |
| $\overline{P E}$ | 9 | parallel enable input (active LOW) |
| $\overline{C E T}$ | 10 | count enable carry input (active LOW) |
| Q3 | 11 | flip-flop output |
| Q2 | 12 | flip-flop output |
| Q1 | 13 | flip-flop output |
| Q0 | 14 | flip-flop output |
| $\overline{T C}$ | 15 | terminal count output (active LOW) |
| $V_{C C}$ | 16 | supply voltage |

## 7. Functional description

### 7.1 Function table

Table 4: Function table [1]

| Operating modes | Input |  |  |  |  |  | Output |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | CP | U/D | CEP | CET | PE | Dn | Qn | TC |
| Parallel load$(\mathrm{Dn} \rightarrow \mathrm{Qn})$ | $\uparrow$ | X | X | X | 1 | 1 | L | * |
|  | $\uparrow$ | X | X | X | 1 | h | H | * |
| Count up (increment) | $\uparrow$ | h | 1 | 1 | h | X | count up | * |
| Count down (decrement) | $\uparrow$ | 1 | 1 | 1 | h | X | count down | * |
| Hold (do nothing) | $\uparrow$ | X | h | X | h | X | qn | * |
|  | $\uparrow$ | X | X | X | h | X | qn | H |

[1] $\mathrm{H}=\mathrm{HIGH}$ voltage level steady state.
$\mathrm{h}=$ HIGH voltage level one setup time prior to the LOW-to-HIGH clock transition.
$\mathrm{L}=\mathrm{LOW}$ voltage level steady state.
I = LOW voltage level one setup time prior to the LOW-to-HIGH clock transition.
qn = Lower case letters indicate state of referenced output prior to the LOW-to-HIGH clock transition.
X = Don't care.
$\uparrow=$ LOW-to-HIGH clock transition.

* $=$ The $\overline{T C}$ is LOW when $\overline{\text { CET }}$ is LOW and the counter is at terminal count.

Terminal count up is (HHHH) and terminal count down is (LLLL).


Fig 6. State diagram.


Illustrated is the following sequence:

- Load (preset) to thirteen.
- count up to fourteen, fifteen (maximum), zero, one and two.
- Inhibit.
- Countdown to one, zero (minimum), fifteen, fourteen and thirteen.

Fig 7. Typical timing sequence.

## 8. Limiting values

Table 5: Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
| :--- | :--- | :--- | :--- | :--- | :--- |
| $\mathrm{V}_{\mathrm{CC}}$ | supply voltage |  | -0.5 | +6.5 | V |
| $\mathrm{I}_{\mathrm{IK}}$ | input diode current | $\mathrm{V}_{\mathrm{I}}<0 \mathrm{~V}$ | - | -50 | mA |
| $\mathrm{~V}_{\mathrm{I}}$ | input voltage |  | $\underline{[1]}-0.5$ | +5.5 | V |
| $\mathrm{I}_{\mathrm{OK}}$ | output diode current | $\mathrm{V}_{\mathrm{O}}>\mathrm{V}_{\mathrm{CC}}$ or $\mathrm{V}_{\mathrm{O}}<0 \mathrm{~V}$ | - | $\pm 50$ | mA |
| $\mathrm{~V}_{\mathrm{O}}$ | output voltage |  | $\underline{[1]}-0.5$ | $\mathrm{~V}_{\mathrm{CC}}+0.5$ | V |
| $\mathrm{I}_{\mathrm{O}}$ | output source or sink <br> current |  | - | $\pm 50$ | mA |
|  |  |  |  |  |  |
| $\mathrm{I}_{\mathrm{CC}}, \mathrm{I}_{\mathrm{GND}}$ | $\mathrm{V}_{\mathrm{CC}}$ or GND current | $\mathrm{V}_{\mathrm{O}}=0 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{CC}}$ | $\pm 100$ | mA |  |
| $\mathrm{~T}_{\text {stg }}$ | storage temperature |  | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{P}_{\text {tot }}$ | power dissipation | $\mathrm{T}_{\mathrm{amb}}=-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | $\underline{[2]}-$ | 500 | mW |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
[2] For SO16 packages: above $70^{\circ} \mathrm{C}, \mathrm{P}_{\text {tot }}$ derates linearly with $8 \mathrm{~mW} / \mathrm{K}$.
For (T)SSOP16 packages: above $60^{\circ} \mathrm{C}, \mathrm{P}_{\text {tot }}$ derates linearly with $5.5 \mathrm{~mW} / \mathrm{K}$. For DHVQFN16 packages: above $60^{\circ} \mathrm{C}, \mathrm{P}_{\text {tot }}$ derates linearly with $4.5 \mathrm{~mW} / \mathrm{K}$.

## 9. Recommended operating conditions

Table 6: Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Max | Unit |
| :--- | :--- | :--- | :--- | :--- | :--- |
| $\mathrm{V}_{\mathrm{CC}}$ | supply voltage | for maximum speed performance | 2.7 | 3.6 | V |
|  |  | for low-voltage applications | 1.2 | 3.6 | V |
| $\mathrm{~V}_{\mathrm{I}}$ | input voltage |  | 0 | 5.5 | V |
| $\mathrm{~V}_{\mathrm{O}}$ | output voltage |  | 0 | $\mathrm{~V}_{\mathrm{CC}}$ | V |
| $\mathrm{T}_{\mathrm{amb}}$ | operating temperature | free-air | -40 | +125 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{t}_{\mathrm{r}}, \mathrm{t}_{\mathrm{f}}$ | input rise and fall times | $\mathrm{V}_{\mathrm{CC}}=1.2 \mathrm{~V}$ to 2.7 V | 0 | 20 | $\mathrm{~ns} / \mathrm{V}$ |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ to 3.6 V | 0 | 10 | $\mathrm{~ns} / \mathrm{V}$ |

## 10. Static characteristics

Table 7: Static characteristics
At recommended operating conditions; voltages are referenced to GND (ground = OV).

| Symbol Parameter | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{T}_{\text {amb }}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C} \underline{[1]}$ |  |  |  |  |  |
| HIGH-level input voltage | $\mathrm{V}_{\mathrm{CC}}=1.2 \mathrm{~V}$ | $\mathrm{V}_{\mathrm{CC}}$ | - | - | V |
|  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ to 3.6 V | 2.0 | - | - | V |
| LOW-level input voltage | $\mathrm{V}_{\mathrm{CC}}=1.2 \mathrm{~V}$ | - | - | GND | V |
|  | $\mathrm{V}_{C C}=2.7 \mathrm{~V}$ to 3.6 V | - | - | 0.8 | V |

Table 7: Static characteristics ...continued
At recommended operating conditions; voltages are referenced to GND (ground = OV).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OH}}$ | HIGH-level output voltage | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\text {IH }}$ or $\mathrm{V}_{\text {IL }}$ |  |  |  |  |
|  |  | $\mathrm{I}_{\mathrm{O}}=-100 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ to 3.6 V | $V_{C C}-0.2$ | $\mathrm{V}_{\mathrm{CC}}$ | - | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=-12 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ | $V_{C C}-0.5$ | - | - | V |
|  |  | $\mathrm{l}_{\mathrm{O}}=-18 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ | $V_{C C}-0.6$ | - | - | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=-24 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ | $\mathrm{V}_{C C}-0.8$ | - | - | V |
| $\mathrm{V}_{\text {OL }}$ | LOW-level output voltage | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\text {IH }}$ or $\mathrm{V}_{\text {IL }}$ |  |  |  |  |
|  |  | $\mathrm{I}_{\mathrm{O}}=100 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ to 3.6 V | - | GND | 0.2 | V |
|  |  | $\mathrm{l}_{\mathrm{O}}=12 \mathrm{~mA} ; \mathrm{V}_{\mathrm{cc}}=2.7 \mathrm{~V}$ | - | - | 0.4 | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=24 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ | - | - | 0.55 | V |
| $\mathrm{I}_{\mathrm{LI}}$ | input leakage current | $\mathrm{V}_{C C}=3.6 \mathrm{~V} ; \mathrm{V}_{\mathrm{I}}=5.5 \mathrm{~V}$ or GND | - | $\pm 0.1$ | $\pm 5$ | $\mu \mathrm{A}$ |
| Icc | quiescent supply current | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=3.6 \mathrm{~V} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}} \text { or } \mathrm{GND} ; \\ & \mathrm{I}_{\mathrm{O}}=0 \mathrm{~A} \end{aligned}$ | - | 0.1 | 10 | $\mu \mathrm{A}$ |
| $\Delta \mathrm{l}_{\text {CC }}$ | additional quiescent supply current per input pin | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V} \text { to } 3.6 \mathrm{~V} ; \\ & \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}-0.6 \mathrm{~V} ; \mathrm{I}_{\mathrm{O}}=0 \mathrm{~A} \end{aligned}$ | - | 5 | 500 | $\mu \mathrm{A}$ |
| $\mathrm{C}_{1}$ | input capacitance |  | - | 5.0 | - | pF |
| $\mathrm{T}_{\text {amb }}=-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{IH}}$ | HIGH-level input voltage | $\mathrm{V}_{\mathrm{CC}}=1.2 \mathrm{~V}$ | $\mathrm{V}_{\mathrm{CC}}$ | - | - | V |
|  |  | $\mathrm{V}_{C C}=2.7 \mathrm{~V}$ to 3.6 V | 2.0 | - | - | V |
| $\mathrm{V}_{\text {IL }}$ | LOW-level input voltage | $\mathrm{V}_{\mathrm{CC}}=1.2 \mathrm{~V}$ | - | - | GND | V |
|  |  | $\mathrm{V}_{\text {CC }}=2.7 \mathrm{~V}$ to 3.6 V | - | - | 0.8 | V |
| $\mathrm{V}_{\mathrm{OH}}$ | HIGH-level output voltage | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\text {IH }}$ or $\mathrm{V}_{\text {IL }}$ |  |  |  |  |
|  |  | $\mathrm{l}_{\mathrm{O}}=-100 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ to 3.6 V | $V_{C C}-0.3$ | - | - | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=-12 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ | $V_{C C}-0.65$ | - | - | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=-18 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ | $V_{C C}-0.75$ | - | - | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=-24 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ | $\mathrm{V}_{\mathrm{CC}}-1$ | - | - | V |
| $\mathrm{V}_{\text {OL }}$ | LOW-level output voltage | $\mathrm{V}_{1}=\mathrm{V}_{\text {IH }}$ or $\mathrm{V}_{\text {IL }}$ |  |  |  |  |
|  |  | $\mathrm{I}_{\mathrm{O}}=100 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ to 3.6 V | - | - | 0.3 | V |
|  |  | $\mathrm{l}_{\mathrm{O}}=12 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ | - | - | 0.6 | V |
|  |  | $\mathrm{l}_{\mathrm{O}}=24 \mathrm{~mA} ; \mathrm{V}_{\mathrm{cc}}=3.0 \mathrm{~V}$ | - | - | 0.8 | V |
| $\mathrm{I}_{\mathrm{LI}}$ | input leakage current | $\mathrm{V}_{\mathrm{CC}}=3.6 \mathrm{~V} ; \mathrm{V}_{\mathrm{I}}=5.5 \mathrm{~V}$ or GND | - | - | $\pm 20$ | $\mu \mathrm{A}$ |
| $I_{\text {cc }}$ | quiescent supply current | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=3.6 \mathrm{~V} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}} \text { or } \mathrm{GND} ; \\ & \mathrm{I}_{\mathrm{O}}=0 \mathrm{~A} \end{aligned}$ | - | - | 40 | $\mu \mathrm{A}$ |
| $\Delta \mathrm{l}_{\mathrm{CC}}$ | additional quiescent supply current per input pin | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V} \text { to } 3.6 \mathrm{~V} ; \\ & \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}-0.6 \mathrm{~V} ; \mathrm{I}_{\mathrm{O}}=0 \mathrm{~A} \end{aligned}$ | - | - | 5000 | $\mu \mathrm{A}$ |

[1] All typical values are measured at $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{amb}}=25^{\circ} \mathrm{C}$.

## 11. Dynamic characteristics

Table 8: Dynamic characteristics
$G N D=0 \mathrm{~V} ; t_{r}=t_{f} \leq 2.5 \mathrm{~ns} ; C_{L}=50 \mathrm{pF} ; R_{L}=500 \Omega$; see Figure 13.

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{T}_{\text {amb }}=-40{ }^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C} \underline{[1]}$ |  |  |  |  |  |  |
| $\mathrm{t}_{\text {PHL }}$, tPLH | propagation delay CP to Qn | see Figure 8 |  |  |  |  |
|  |  | $\mathrm{V}_{C C}=1.2 \mathrm{~V}$ | - | 17 | - | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ | 1.5 | - | 7.2 | ns |
|  |  | $\mathrm{V}_{C C}=3.0 \mathrm{~V}$ to 3.6 V | [2] 1.5 | 4.0 | 8.0 | ns |
|  | propagation delay CP to $\overline{\mathrm{TC}}$ | see Figure 8 |  |  |  |  |
|  |  | $\mathrm{V}_{C C}=1.2 \mathrm{~V}$ | - | 21 | - | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ | 1.5 | - | 8.8 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ to 3.6 V | [2] 1.5 | 4.8 | 6.7 | ns |
|  | propagation delay $\overline{\mathrm{CET}}$ to $\overline{\mathrm{TC}}$ | see Figure 9 |  |  |  |  |
|  |  | $\mathrm{V}_{C C}=1.2 \mathrm{~V}$ | - | 19 | - | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ | 1.5 | - | 7.2 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ to 3.6 V | [2] 1.5 | 4.1 | 7.2 | ns |
|  | propagation delay U/D to $\overline{\mathrm{TC}}$ | see Figure 10 |  |  |  |  |
|  |  | $\mathrm{V}_{C C}=1.2 \mathrm{~V}$ | - | 21 | - | ns |
|  |  | $\mathrm{V}_{C C}=2.7 \mathrm{~V}$ | 1.5 | - | 8.2 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ to 3.6 V | [2] 1.5 | 3.7 | 7.0 | ns |
| tw | clock pulse width HIGH or LOW | see Figure 8 |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ | 5.0 | - | - | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ to 3.6 V | [2] 4.0 | 1.2 | - | ns |
| $t_{s u}$ | set-up time Dn to CP | see Figure 11 |  |  |  |  |
|  |  | $\mathrm{V}_{C C}=2.7 \mathrm{~V}$ | 3.0 | - | - | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ to 3.6 V | [2] 2.5 | 1.0 | - | ns |
|  | set-up time $\overline{\text { PE }}$ to CP | see Figure 11 |  |  |  |  |
|  |  | $\mathrm{V}_{C C}=2.7 \mathrm{~V}$ | 3.5 | - | - | ns |
|  |  | $\mathrm{V}_{C C}=3.0 \mathrm{~V}$ to 3.6 V | [2] 3.0 | 1.2 | - | ns |
|  | set-up time U/D to CP | see Figure 12 |  |  |  |  |
|  |  | $\mathrm{V}_{C C}=2.7 \mathrm{~V}$ | 6.5 | - | - | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ to 3.6 V | [2] 5.5 | 2.8 | - | ns |
|  | set-up time $\overline{\mathrm{CEP}}, \overline{\mathrm{CET}}$ to CP | see Figure 12 |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ | 5.5 | - | - | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ to 3.6 V | [2] 4.5 | 2.1 | - | ns |
| $t_{n}$ | hold time Dn, $\overline{\mathrm{PE}}, \overline{\mathrm{CEP}}, \overline{\mathrm{CET}}$, U/D to CP | see Figure 11 and 12 |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ | 0.0 | - | - | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ to 3.6 V | [2] 0.5 | 0.0 | - | ns |
| $\mathrm{f}_{\text {max }}$ | maximum clock pulse frequency | see Figure 8 |  |  |  |  |
|  |  | $\mathrm{V}_{C C}=2.7 \mathrm{~V}$ | 150 | - | - | MHz |
|  |  | $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ to 3.6 V | [2] 150 | 200 | - | MHz |
| 939775013818 |  |  | ๑Koninklike Philips Electronics N.V. 2004. All rights reserved |  |  |  |
| Product da | sheet | Rev. 04 - 14 October |  |  |  | 10 o |

Table 8: Dynamic characteristics ...continued $G N D=0 \mathrm{~V} ; t_{r}=t_{f} \leq 2.5 \mathrm{~ns} ; C_{L}=50 \mathrm{pF} ; R_{L}=500 \Omega$; see Figure 13.

[1] All typical values are measured at $\mathrm{T}_{\text {amb }}=25^{\circ} \mathrm{C}$.
[2] Typical values are measured at $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}$.
[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.
[4] $\mathrm{C}_{P D}$ is used to determine the dynamic power dissipation ( $\mathrm{P}_{\mathrm{D}}$ in $\mu \mathrm{W}$ ).
$P_{D}=C_{P D} \times V_{C C}{ }^{2} \times f_{i} \times N+\Sigma\left(C_{L} \times V_{C C}{ }^{2} \times f_{0}\right)$ where:
$\mathrm{f}_{\mathrm{i}}=$ input frequency in MHz ;
$\mathrm{f}_{\mathrm{o}}=$ output frequency in MHz ;
$\mathrm{C}_{\mathrm{L}}$ = output load capacity in pF ;
$\mathrm{V}_{\mathrm{CC}}=$ supply voltage in Volts;
$\mathrm{N}=$ total load switching outputs;
$\Sigma\left(C_{L} \times V_{C C}{ }^{2} \times f_{0}\right)=$ sum of the outputs.
[5] The condition is $\mathrm{V}_{\mathrm{I}}=\mathrm{GND}$ to $\mathrm{V}_{\mathrm{Cc}}$.

## 12. Waveforms



Measurement points are given in Table 9.
Logic levels: $\mathrm{V}_{\mathrm{OL}}$ and $\mathrm{V}_{\mathrm{OH}}$ are the typical output voltage drop that occur with the output load.
Fig 8. Clock (CP) to outputs (Qn, $\overline{\mathrm{TC}}$ ) propagation delays, the clock pulse width and the maximum clock frequency.


Measurement points are given in Table 9.
Logic levels: $\mathrm{V}_{\mathrm{OL}}$ and $\mathrm{V}_{\mathrm{OH}}$ are the typical output voltage drop that occur with the output load.
Fig 9. Input ( $\overline{\mathrm{CET}}$ ) to output ( $\overline{\mathrm{TC}}$ ) propagation delays.


Measurement points are given in Table 9.
Logic levels: $\mathrm{V}_{\mathrm{OL}}$ and $\mathrm{V}_{\mathrm{OH}}$ are the typical output voltage drop that occur with the output load.
Fig 10. The up/down control input (U/D) to output (TC) propagation delays.


The shaded areas indicate when the input is permitted to change for predictable output performance.

Measurement points are given in Table 9.
Logic levels: $\mathrm{V}_{\mathrm{OL}}$ and $\mathrm{V}_{\mathrm{OH}}$ are the typical output voltage drop that occur with the output load.
Fig 11. Set-up and hold times for the input (Dn) and parallel enable input ( $\overline{\mathrm{PE}}$ ).
$\overline{\mathrm{CEP}}, \overline{\mathrm{CET}}, \mathrm{U} / \overline{\mathrm{D}}$ input
CP input


The shaded areas indicate when the input is permitted to change for predictable output performance.
Measurement points are given in Table 9.
Logic levels: $\mathrm{V}_{\mathrm{OL}}$ and $\mathrm{V}_{\mathrm{OH}}$ are the typical output voltage drop that occur with the output load.
Fig 12. Set-up and hold times for count enable inputs (CEP and CET) and control input (U/D).

Table 9: Measurement points

| Supply voltage | Input | Output |
| :--- | :--- | :--- |
| $\mathbf{V}_{\mathbf{C C}}$ | $\mathbf{V}_{\mathbf{M}}$ | $\mathbf{V}_{\mathbf{M}}$ |
| 1.2 V | $0.5 \times \mathrm{V}_{\mathrm{CC}}$ | $0.5 \times \mathrm{V}_{\mathrm{CC}}$ |
| 2.7 V | 1.5 V | 1.5 V |
| 3.0 V to 3.6 V | 1.5 V | 1.5 V |



Test data is given in Table 10.
Definitions test circuit:
$R_{T}=$ Termination resistance should be equal to output impedance $Z_{o}$ of the pulse generator.
$\mathrm{C}_{\mathrm{L}}=$ Load capacitance including jig and probe capacitance.
$R_{L}=$ Load resistance.
Fig 13. Load circuitry for switching times.

Table 10: Measurement points

| Supply voltage | Input | Load | Position S1 |  |  |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| $\mathbf{V}_{\mathbf{C C}}$ | $\mathbf{V}_{\mathbf{I}}$ | $\mathbf{C}_{\mathbf{L}}$ | $\mathbf{R}_{\mathbf{L}}$ | $\mathbf{t}_{\text {PLH }}, \mathbf{t}_{\text {PHL }}$ | $\mathbf{t}_{\text {PZH }}, \mathbf{t}_{\text {PHZ }}$ | $\mathbf{t}_{\text {PZL }}, \mathbf{t}_{\text {PLZ }}$ |
| 1.2 V | $\mathrm{~V}_{\mathrm{CC}}$ | 50 pF | $500 \Omega$ [1] | open | GND | $2 \times \mathrm{V}_{\mathrm{CC}}$ |
| 2.7 V | 2.7 V | 50 pF | $500 \Omega$ | open | GND | $2 \times \mathrm{V}_{\mathrm{CC}}$ |
| 3.0 V to 3.6 V | 2.7 V | 50 pF | $500 \Omega$ | open | GND | $2 \times \mathrm{V}_{\mathrm{CC}}$ |

[1] The circuit performs better when $R_{L}=1000 \Omega$.

## 13. Application information



Fig 14. Synchronous multistage counting scheme.

## 14. Package outline



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | $\begin{gathered} \mathrm{A} \\ \max . \end{gathered}$ | $\mathrm{A}_{1}$ | $\mathrm{A}_{2}$ | $\mathrm{A}_{3}$ | $\mathrm{b}_{\mathrm{p}}$ | c | $D^{(1)}$ | $E^{(1)}$ | e | $\mathrm{H}_{\mathrm{E}}$ | L | $L_{p}$ | Q | v | w | y | $\mathrm{Z}^{(1)}$ | $\theta$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 1.75 | $\begin{aligned} & 0.25 \\ & 0.10 \end{aligned}$ | $\begin{aligned} & 1.45 \\ & 1.25 \end{aligned}$ | 0.25 | $\begin{aligned} & 0.49 \\ & 0.36 \end{aligned}$ | $\begin{aligned} & 0.25 \\ & 0.19 \end{aligned}$ | $\begin{gathered} 10.0 \\ 9.8 \end{gathered}$ | $\begin{aligned} & 4.0 \\ & 3.8 \end{aligned}$ | 1.27 | $\begin{aligned} & 6.2 \\ & 5.8 \end{aligned}$ | 1.05 | $\begin{aligned} & 1.0 \\ & 0.4 \end{aligned}$ | $\begin{aligned} & 0.7 \\ & 0.6 \end{aligned}$ | 0.25 | 0.25 | 0.1 | $\begin{aligned} & 0.7 \\ & 0.3 \end{aligned}$ | $\begin{aligned} & 8^{\circ} \\ & 0^{\circ} \end{aligned}$ |
| inches | 0.069 | $\begin{aligned} & 0.010 \\ & 0.004 \end{aligned}$ | $\begin{aligned} & 0.057 \\ & 0.049 \end{aligned}$ | 0.01 | $\begin{aligned} & 0.019 \\ & 0.014 \end{aligned}$ | $\begin{array}{\|l\|} \hline 0.0100 \\ 0.0075 \end{array}$ | $\begin{aligned} & \hline 0.39 \\ & 0.38 \end{aligned}$ | $\begin{aligned} & 0.16 \\ & 0.15 \end{aligned}$ | 0.05 | $\begin{aligned} & \hline 0.244 \\ & 0.228 \end{aligned}$ | 0.041 | $\begin{aligned} & 0.039 \\ & 0.016 \end{aligned}$ | $\begin{aligned} & 0.028 \\ & 0.020 \end{aligned}$ | 0.01 | 0.01 | 0.004 | $\begin{aligned} & 0.028 \\ & 0.012 \end{aligned}$ |  |

Note

1. Plastic or metal protrusions of 0.15 mm ( 0.006 inch ) maximum per side are not included.

| OUTLINE <br> VERSION | REFERENCES |  |  |  | EUROPEAN <br> PROJECTION | ISSUE DATE |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | JEITA |  |  |  |
| SOT109-1 | $076 E 07$ | MS-012 |  |  | - |  |

Fig 15. Package outline SOT109-1 (SO16).
939775013818


DIMENSIONS (mm are the original dimensions)

| UNIT | $\begin{gathered} \text { A } \\ \text { max. } \end{gathered}$ | $\mathrm{A}_{1}$ | $\mathrm{A}_{2}$ | $\mathrm{A}_{3}$ | $\mathrm{b}_{\mathrm{p}}$ | c | $D^{(1)}$ | $E^{(1)}$ | e | $\mathrm{H}_{\mathrm{E}}$ | L | $L_{p}$ | Q | v | w | y | $Z^{(1)}$ | $\theta$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 2 | $\begin{aligned} & 0.21 \\ & 0.05 \end{aligned}$ | $\begin{aligned} & 1.80 \\ & 1.65 \end{aligned}$ | 0.25 | $\begin{aligned} & 0.38 \\ & 0.25 \end{aligned}$ | $\begin{aligned} & 0.20 \\ & 0.09 \end{aligned}$ | $\begin{aligned} & \hline 6.4 \\ & 6.0 \end{aligned}$ | $\begin{aligned} & 5.4 \\ & 5.2 \end{aligned}$ | 0.65 | $\begin{aligned} & 7.9 \\ & 7.6 \end{aligned}$ | 1.25 | $\begin{aligned} & 1.03 \\ & 0.63 \end{aligned}$ | $\begin{aligned} & 0.9 \\ & 0.7 \end{aligned}$ | 0.2 | 0.13 | 0.1 | $\begin{aligned} & 1.00 \\ & 0.55 \end{aligned}$ | $8^{\circ}$ 0 |

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

| OUTLINE <br> VERSION | REFERENCES |  |  |  | EUROPEAN <br> PROJECTION | ISSUE DATE |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | JEITA |  |  | - |
| SOT338-1 |  | MO-150 |  |  | $-99-12-27$ |  |

Fig 16. Package outline SOT338-1 (SSOP16).

DIMENSIONS (mm are the original dimensions)

| UNIT | $\mathbf{A}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathbf{m a x}$. |  | $\mathbf{A}_{\mathbf{1}} \quad \mathbf{A}_{\mathbf{2}} \quad \mathbf{A}_{\mathbf{3}} \quad \mathbf{b}_{\mathbf{p}} \quad \mathbf{c}$

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES |  |  | EUROPEAN PROJECTION | ISSUE DATE |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | JEITA |  |  |
| SOT403-1 |  | MO-153 |  | - | $\begin{aligned} & -99-12-27 \\ & 03-02-18 \end{aligned}$ |

Fig 17. Package outline SOT403-1 (TSSOP16).

DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads;
16 terminals; body $2.5 \times 3.5 \times 0.85 \mathrm{~mm}$


Fig 18. Package outline SOT763-1 (DHVQFN16).

## 15. Revision history

Table 11: Revision history

| Document ID | Release date | Data sheet status | Change notice | Doc. number | Supersedes |
| :--- | :--- | :--- | :--- | :--- | :--- |
| 74LVC169_4 | 14102004 | Product data sheet | - | 939775013818 | 74LVC169_3 |
| Modifications: | - Added DHVQFN16 package |  |  |  |  |
|  | - Section 1: corrected logic equations |  |  |  |  |
|  | - Figure 14: | corrected connections between 1st and 2nd counter. |  |  |  |
| 74LVC169_3 | 20040512 | Product data sheet | - | 939775013026 | 74LVC169_2 |
| 74LVC169_2 | 19980520 | Product specification |  | 939775004498 | 74LVC169_1 |

## 16. Data sheet status

| Level | Data sheet status $\underline{[1]}$ | Product status $\underline{[2][3]}$ [3] | Definition <br> I |
| :--- | :--- | :--- | :--- |
| Objective data | Development | This data sheet contains data from the objective specification for product development. Philips <br> Semiconductors reserves the right to change the specification in any manner without notice. |  |
| II | Preliminary data | Qualification | This data sheet contains data from the preliminary specification. Supplementary data will be published <br> at a later date. Philips Semiconductors reserves the right to change the specification without notice, in <br> order to improve the design and supply the best possible product. |
| III | Product data | Production | This data sheet contains data from the product specification. Philips Semiconductors reserves the <br> right to make changes at any time in order to improve the design, manufacturing and supply. Relevant <br> changes will be communicated via a Customer Product/Process Change Notification (CPCN). |

[1] Please consult the most recently issued data sheet before initiating or completing a design.
[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.
[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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Limiting values definition - Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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